



SMD Comm COG HV, Ceramic, 47 pF, 5%, 2,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



General Information		
Series	SMD Comm COG HV	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	25 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

10000

Packaging Quantity

W	1.6mm +/-0.2mm	Tolerance
Т	1mm +/-0.10mm	Voltage DC
S	1.5mm MIN	Dielectric Withstanding Voltage
В	0.5mm +/-0.25mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change with
Packaging	T&R, 330mm, Plastic Tape	Reference to +25°C and 0 VDC

Specifications	
Capacitance	47 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2,400 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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